This document contains a schematic diagram of a PLC LED Driver. The diagram includes various components and connections, such as VIN, CP14, CP23, EN5, SS6, FB, OUT, SW, and VO, among others. The schematic is used for designing and implementing a LED driver circuit, which is part of a Texas Instruments product.

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These assemblies are ESD sensitive, ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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